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<u>Texas Instruments</u> <u>DRV5053CAEDBZRQ1</u>

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Datasheet of DRV5053CAEDBZRQ1 - IC HALL SENSOR DGTL 3SOT23

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DRV5053-Q1

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### DRV5053-Q1 Automotive Analog-Bipolar Hall Effect Sensor

#### 1 Features

- · Linear Output Hall Sensor
- AEC-Q100 Qualified for Automotive Applications
  - Grade 1: T<sub>A</sub> = -40 to 125°C (Q, See Figure 17)
  - Grade 0:  $T_A = -40$  to 150°C (E, See Figure 17)
- Superior Temperature Stability
  - Sensitivity ±10% Over Temperature
- High Sensitivity Options:
  - -11 mV/mT (OA, See Figure 17)
  - 23 mV/mT (PA)
  - –45 mV/mT (RA)
  - 90 mV/mT (VA)
  - +23 mV/mT (CA)
  - +45 mV/mT (EA)
- · Supports a Wide Voltage Range
  - 2.7 to 38 V
  - No External Regulator Required
- Amplified Output Stage
  - 2.3-mA Sink, 300 µA Source
- Output Voltage: 0.2 ~ 1.8 V
  - -B=0 mT, OUT =1 V
- Fast Power-On: 35 μs
- Small Package and Footprint
  - Surface Mount 3-Pin SOT-23 (DBZ)
    - 2.92 mm × 2.37 mm
  - Through-Hole 3-Pin TO-92 (LPG)
    - $-4.00 \text{ mm} \times 3.15 \text{ mm}$

#### • Protection Features

- Reverse Supply Protection (up to –22 V)
- Supports up to 40-V Load Dump
- Output Short-Circuit Protection
- Output Current Limitation
- OUT Short to Battery Protection

### 2 Applications

- Flow Meters
- Docking Adjustment
- Vibration Correction
- Damper Controls

#### 3 Description

The DRV5053-Q1 device is a chopper-stabilized Hall IC that offers a magnetic sensing solution with superior sensitivity stability over temperature and integrated protection features.

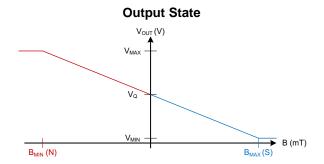
The 0- to 2-V analog output responds linearly to the applied magnetic flux density, and distinguishes the polarity of magnetic field direction. A wide operating voltage range from 2.7 to 38 V with reverse polarity protection up to -22 V makes the device suitable for a wide range of automotive and consumer applications.

Internal protection functions are provided for reverse supply conditions, load dump, and output short circuit or overcurrent.

#### Device Information<sup>(1)</sup>

PART NUMBER	PACKAGE	BODY SIZE (NOM)		
DDV/5052 O4	SOT-23 (3)	2.92 mm × 1.30 mm		
DRV5053-Q1	TO-92 (3)	4.00 mm × 3.15 mm		

(1) For all available packages, see the orderable addendum at the end of the data sheet.









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### 4 Revision History

С	hanges from Original (December 2014) to Revision A	Page
•	Corrected body size of SOT-23 package and SIP package name to TO-92	
•	Added B <sub>MAX</sub> to Absolute Maximum Ratings	4
•	Removed table notes regarding testing for the operating junction temperature in Absolute Maximum Ratings	4
•	Updated the typical value for B <sub>N</sub> and V <sub>N</sub> for each version	!
•	Updated Figure 6	
•	Updated the Functional Block Diagram	8
	Updated Output Stage	
	Updated package tape and reel options for M and blank	
	Added Community Passures	10

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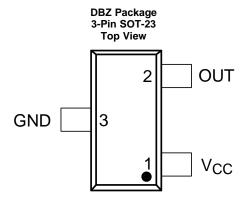
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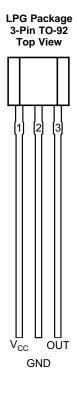
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### 5 Pin Configuration and Functions

For additional configuration information, see *Device Markings* and *Mechanical, Packaging, and Orderable Information*.





#### **Pin Functions**

	PIN		TYPE	DESCRIPTION	
NAME	DBZ	LPG	ITPE	DESCRIPTION	
GND	3	2	GND	Ground pin	
V <sub>CC</sub>	1	1	Power	2.7 to 38 V power supply. Bypass this pin to the GND pin with a 0.01- $\mu$ F (minimum) ceramic capacitor rated for V <sub>CC</sub> .	
OUT	2	3	Output	Hall sensor analog output. 1 V output corresponds to B = 0 mT	



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### 6 Specifications

#### 6.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)<sup>(1)</sup>

		MIN	MAX	UNIT
	V <sub>CC</sub>	-22 <sup>(2)</sup>	40	V
Power supply voltage	Voltage ramp rate (V <sub>CC</sub> ), V <sub>CC</sub> < 5 V	Unlin	nited	1///
	Voltage ramp rate (V <sub>CC</sub> ), V <sub>CC</sub> > 5 V	0	2	V/µs
Output pin voltage			2.5	V
Output pin reverse current during reve	rse supply condition	0	-20	mA
Magnetic flux density, B <sub>MAX</sub>		Unlin	nited	
Operating investigation temperature. T	Q, see Figure 17	-40	150	°C
Operating junction temperature, T <sub>J</sub>	E, see Figure 17	-40	175	C
Storage temperature, T <sub>stg</sub>			150	°C

<sup>(1)</sup> Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under Recommended Operating Conditions. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

#### 6.2 ESD Ratings

			VALUE	UNIT	
V	Electrostatic	Human body model (HBM), per ANSI/ESDA/JEDEC JS-001, all pins <sup>(1)</sup>	±2500	V	l
V <sub>(ESD)</sub>	discharge	Charged device model (CDM), per JEDEC specification JESD22-C101, all pins (2)	±500	V	l

<sup>(1)</sup> JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.

#### 6.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)

			MIN	MAX	UNIT
V <sub>CC</sub>	Power supply voltage	Power supply voltage			V
V <sub>OUT</sub>	Output pin voltage (OU	Output pin voltage (OUT)			V
I <sub>SOURCE</sub>	Output pin current source (OUT)			300	μΑ
I <sub>SINK</sub>	Output pin current sink (OUT)		0	2.3	mA
_	Operating ambient temperature	Q, see Figure 17	-40	125	00
1 <sub>A</sub>		E, see Figure 17	-40	150	°C

#### 6.4 Thermal Information

		DRV5		
	THERMAL METRIC <sup>(1)</sup>	DBZ (SOT-23)	LPG (TO-92)	UNIT
		3 PINS	3 PINS	
$R_{\theta JA}$	Junction-to-ambient thermal resistance	333.2	180	°C/W
R <sub>0JC(top)</sub>	Junction-to-case (top) thermal resistance	99.9	98.6	°C/W
$R_{\theta JB}$	Junction-to-board thermal resistance	66.9	154.9	°C/W
ΨЈТ	Junction-to-top characterization parameter	4.9	40	°C/W
ΨЈВ	Junction-to-board characterization parameter	65.2	154.9	°C/W

For more information about traditional and new thermal metrics, see the Semiconductor and IC Package Thermal Metrics application report, SPRA953.

<sup>(2)</sup> Ensured by design. Only tested to -20 V.

<sup>(2)</sup> JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

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#### 6.5 Electrical Characteristics

over operating free-air temperature range (unless otherwise noted)

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
POWER SUPP	LIES (V <sub>CC</sub> )					
V <sub>CC</sub>	V <sub>CC</sub> operating voltage		2.7		38	V
	Operating cumply current	$V_{CC} = 2.7 \text{ to } 38 \text{ V}, T_A = 25^{\circ}\text{C}$		2.7		mA
Icc	Operating supply current	$V_{CC} = 2.7 \text{ to } 38 \text{ V}, T_A = T_{A, MAX}^{(1)}$		3	3.6	
t <sub>on</sub>	Power-on time			35	50	μs
PROTECTION	CIRCUITS					
$V_{CCR}$	Reverse supply voltage		-22			V
I <sub>OCP,SOURCE</sub>	Overcurrent protection level	Sourcing current		300		μA
I <sub>OCP,SINK</sub>	Overcurrent protection level	Sinking current		2.3		mA

<sup>(1)</sup> T<sub>A, MAX</sub> is 125°C for Q Grade 1 devices and 150°C for E Grade 0 devices (see Figure 17)

#### 6.6 Switching Characteristics

over operating free-air temperature range (unless otherwise noted)

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT				
ANAL	ANALOG OUTPUT (OUT)									
t <sub>d</sub>	Output delay time	T <sub>A</sub> = 25°C		13	25	μs				

#### 6.7 Magnetic Characteristics

over operating free-air temperature range (unless otherwise noted)

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT <sup>(1)</sup>
V <sub>Q</sub>	Quiescent output	B = 0 mT	0.9	1.02	1.15	V
$f_{BW}$	Bandwidth (2)		20			kHz
B <sub>N</sub>	Input-referred noise (3)	C <sub>OUT</sub> = 50 pF	0.40	0.49	0.79	$mT_{pp}$
Le	Linearity <sup>(4)</sup>	-B <sub>SAT</sub> < B < B <sub>SAT</sub>		1%		
V <sub>OUT MIN</sub>	Output saturation voltage (min)	B < -B <sub>SAT</sub>			0.2	V
V <sub>OUT MAX</sub>	Output saturation voltage (max)	B > B <sub>SAT</sub>	1.8			V
DRV50530	OA: –11 mV/mT					
S	Sensitivity	V <sub>CC</sub> = 3.3 V	-17.5	-11	-5	mV/mT
V <sub>N</sub>	Output-referred noise	$V_{CC}$ = 3.3 V; $R_{OUT}$ = 10 k $\Omega$ ; $C_{OUT}$ = 50 pF		5		${\sf mV_{pp}}$
B <sub>SAT</sub>	Input saturation field	V <sub>CC</sub> = 3.3 V		73		mT
	PA: –23 mV/mT					
S	Sensitivity	V <sub>CC</sub> = 3.3 V	-35	-23	-10	mV/mT
V <sub>N</sub>	Output-referred noise	$V_{CC}$ = 3.3 V; $R_{OUT}$ = 10 k $\Omega$ ; $C_{OUT}$ = 50 pF		11		${\rm mV_{pp}}$
B <sub>SAT</sub>	Input saturation field	V <sub>CC</sub> = 3.3 V		35		mT
B <sub>SAT</sub>	Input saturation field			35		

Bandwidth describes the fastest changing magnetic field that can be detected and translated to the output.

Not tested in production; limits are based on characterization data.

Linearity describes the change in sensitivity across the B-range. The sensitivity near B<sub>SAT</sub> is typically within 1% of the sensitivity near B = 0.



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#### **Magnetic Characteristics (continued)**

over operating free-air temperature range (unless otherwise noted)

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT <sup>(1)</sup>
DRV505	3RA: –45 mV/mT		<u>.</u>		<u> </u>	
S	Sensitivity	V <sub>CC</sub> = 3.3 V	-70	<b>-45</b>	-20	mV/mT
$V_N$	Output-referred noise	$V_{CC}$ = 3.3 V; $R_{OUT}$ = 10 k $\Omega$ ; $C_{OUT}$ = 50 pF		22		$mV_pp$
B <sub>SAT</sub>	Input saturation field	V <sub>CC</sub> = 3.3 V		18		mΤ
	3VA: –90 mV/mT					
S	Sensitivity	V <sub>CC</sub> = 3.3 V	-140	-90	-45	mV/mT
V <sub>N</sub>	Output-referred noise	$V_{CC}$ = 3.3 V; $R_{OUT}$ = 10 k $\Omega$ ; $C_{OUT}$ = 50 pF		44		$mV_{pp}$
B <sub>SAT</sub>	Input saturation field	V <sub>CC</sub> = 3.3 V		9		mΤ
	3CA: 23 mV/mT					
S	Sensitivity	V <sub>CC</sub> = 3.3 V	10	23	35	mV/mT
V <sub>N</sub>	Output-referred noise	$V_{CC}$ = 3.3 V; $R_{OUT}$ = 10 k $\Omega$ ; $C_{OUT}$ = 50 pF		11		${\sf mV_{pp}}$
B <sub>SAT</sub>	Input saturation field	V <sub>CC</sub> = 3.3 V		35		mT
	3EA: 45 mV/mT					
S	Sensitivity	V <sub>CC</sub> = 3.3 V	20	45	70	mV/mT
V <sub>N</sub>	Output-referred noise	$V_{CC} = 3.3 \text{ V}; R_{OUT} = 10 \text{ k}\Omega;$ $C_{OUT} = 50 \text{ pF}$		22		$mV_{pp}$
B <sub>SAT</sub>	Input saturation field	V <sub>CC</sub> = 3.3 V		18		mT

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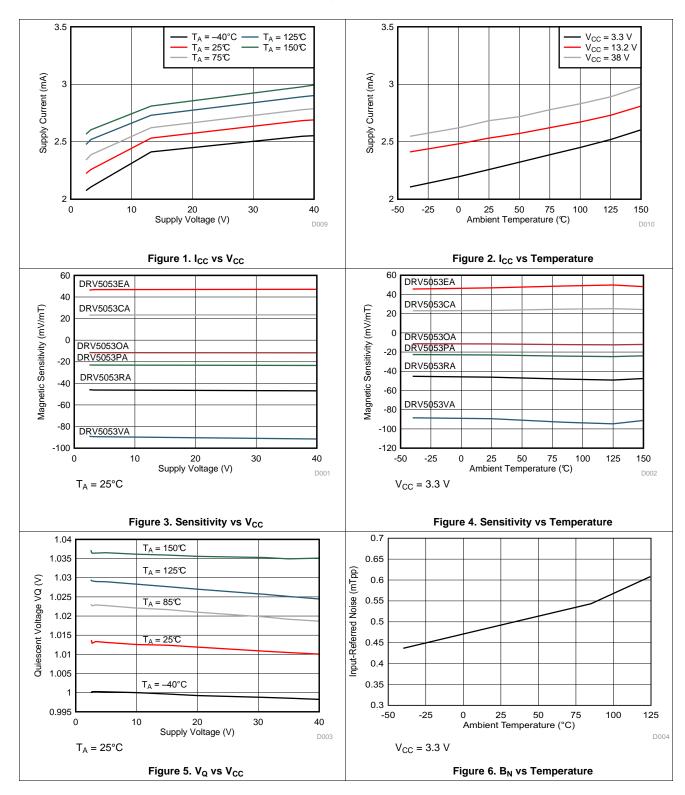
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#### 6.8 Typical Characteristics

T<sub>A</sub> > 125°C data is valid for Grade 0 devices only (E, see Figure 17)



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#### 7 Detailed Description

#### 7.1 Overview

The DRV5053-Q1 device is a chopper-stabilized Hall sensor with an analog output for magnetic sensing applications. The DRV5053-Q1 device can be powered with a supply voltage between 2.7 and 38 V, and will survive -22 V reverse battery conditions continuously. Note that the DRV5053-Q1 device will not be operating when approximately -22 to 2.4 V is applied to  $V_{CC}$  (with respect to GND). In addition, the device can withstand supply voltages up to 40 V for transient durations.

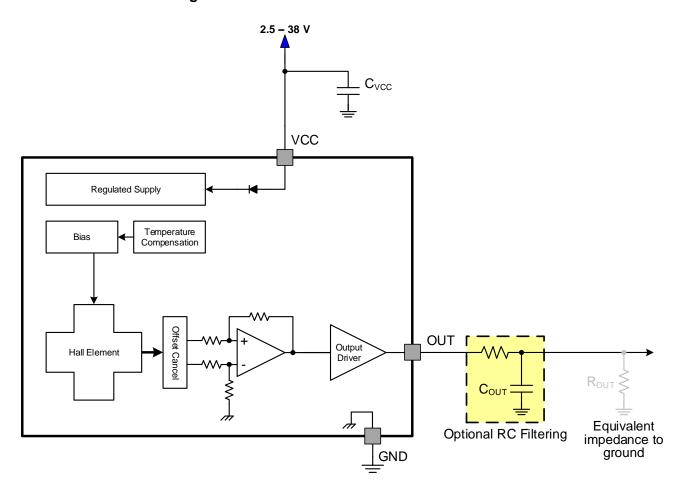
The output voltage is dependent on the magnetic field perpendicular to the package. The absence of a magnetic field will result in OUT = 1 V. A magnetic field will cause the output voltage to change linearly with the magnetic field.

The field polarity is defined as follows: a south pole near the marked side of the package is a positive magnetic field. A north pole near the marked side of the package is a negative magnetic field.

For devices with a negative sensitivity (that is, DRV5053RA: -40 mV/mT), a south pole will cause the output voltage to drop below 1 V, and a north pole will cause the output to rise above 1 V.

For devices with a positive sensitivity (that is, DRV5053EA: +40 mV/mT), a south pole will cause the output voltage to rise above 1 V, and a north pole will cause the output to drop below 1 V.

#### 7.2 Functional Block Diagram



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### 7.3 Feature Description

#### 7.3.1 Field Direction Definition

A positive magnetic field is defined as a south pole near the marked side of the package as shown in Figure 7.

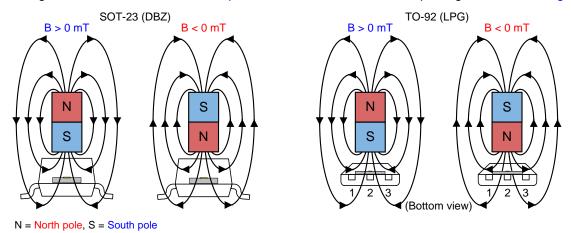


Figure 7. Field Direction Definition

#### 7.3.2 Device Output

The DRV5053-Q1 device output is defined below for negative sensitivity (that is, -45 mV/mT, RA) and positive sensitivity (that is, +45 mV/mT, EA):

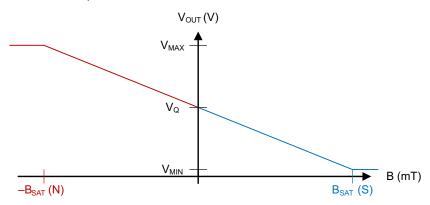


Figure 8. DRV5053-Q1 - Negative Sensitivity

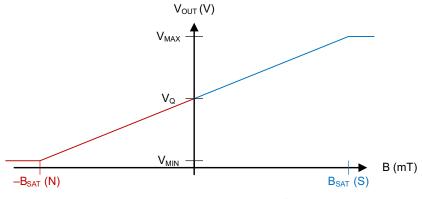


Figure 9. DRV5053-Q1 - Positive Sensitivity

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#### **Feature Description (continued)**

#### 7.3.3 Power-On Time

After applying  $V_{CC}$  to the DRV5053-Q1 device,  $t_{on}$  must elapse before OUT is valid. Figure 10 shows Case 1 and Figure 11 shows case 2; the output is defined assuming a negative sensitivity device and a constant magnetic field  $-B_{SAT} < B < B_{SAT}$ .

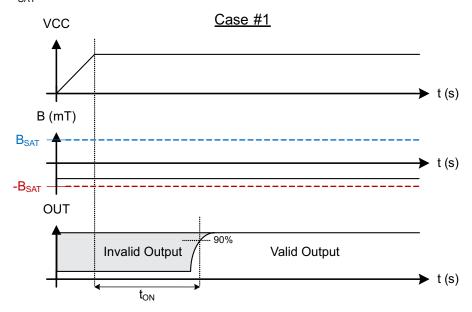


Figure 10. Case 1: Power On When B < 0, North

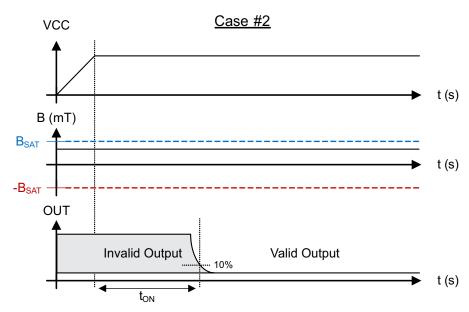


Figure 11. Case 2: Power On When B > 0, South

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#### **Feature Description (continued)**

#### 7.3.4 Output Stage

The DRV5053-Q1 output stage is capable of up to 300- $\mu$ A of current source or 2.3-mA sink. For proper operation, ensure that equivalent output load  $R_{OUT} > 10 \text{ k}\Omega$ .

The capacitive load directly present on the OUT pin should be less than 10 nF to ensure the internal operational amplifier is stable. If an external RC filter is added to reduce noise, it is acceptable to use a resistor  $\geq$  200  $\Omega$  with a capacitor  $\leq$ 0.1  $\mu$ F. For an application example, see *Filtered Typical Application*.

#### 7.3.5 Protection Circuits

An analog current limit circuit limits the current through the output driver. The driver current will be clamped to  $I_{\text{OCP}}$ 

#### 7.3.5.1 Overcurrent Protection (OCP)

An analog current-limit circuit limits the current through the FET. The driver current is clamped to  $I_{OCP}$ . During this clamping, the  $r_{DS(on)}$  of the output FET is increased from the nominal value.

#### 7.3.5.2 Load Dump Protection

The DRV5053-Q1 device operates at DC  $V_{CC}$  conditions up to 38 V nominally, and can additionally withstand  $V_{CC} = 40$  V. No current-limiting series resistor is required for this protection.

#### 7.3.5.3 Reverse Supply Protection

The DRV5053-Q1 device is protected in the event that the  $V_{CC}$  pin and the GND pin are reversed (up to -22 V).

#### **NOTE**

In a reverse supply condition, the OUT pin reverse-current must not exceed the ratings specified in the *Absolute Maximum Ratings*.

#### Table 1.

FAULT	CONDITION	DEVICE	DESCRIPTION	RECOVERY
FET overload (OCP)	I <sub>SINK</sub> ≥ I <sub>OCP</sub>	Operating	Output current is clamped to I <sub>OCP</sub>	I <sub>O</sub> < I <sub>OCP</sub>
Load Dump	38 V < V <sub>CC</sub> < 40 V	Operating	Device will operate for a transient duration	V <sub>CC</sub> ≤ 38 V
Reverse Supply	$-22 \text{ V} < \text{V}_{CC} < 0 \text{ V}$	Disabled	Device will survive this condition	V <sub>CC</sub> ≥ 2.7 V

Product Folder Links: DRV5053-Q1

#### 7.4 Device Functional Modes

The DRV5053-Q1 device is active only when  $V_{CC}$  is between 2.7 and 38 V.

When a reverse supply condition exists, the device is inactive.

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#### 8 Application and Implementation

#### **NOTE**

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

#### 8.1 Application Information

The DRV5053-Q1 device is used in magnetic-field sensing applications.

#### 8.2 Typical Applications

#### 8.2.1 Typical Application With No Filter

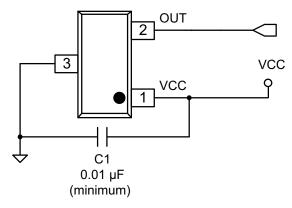


Figure 12. Typical Application Schematic - No Filter

#### 8.2.1.1 Design Requirements

For this design example, use the parameters listed in Table 2 as the input parameters.

**Table 2. Design Parameters** 

DESIGN PARAMETER	REFERENCE	EXAMPLE VALUE
System bandwidth	$f_{BW}$	15 kHz

#### 8.2.1.2 Detailed Design Procedure

The DRV5053-Q1 has internal filtering that limits the bandwidth to at least 20 kHz. For this application no external components are required other than the C1 bypass capacitor, which is 0.01  $\mu$ F minimum. If the analog output OUT is tied to a microcontroller ADC input, the equivalent load must be R > 10 k $\Omega$  and C < 10 nF.

**Table 3. External Components** 

COMPONENT	PIN 1	PIN 2	RECOMMENDED
C1	V <sub>CC</sub>	GND	A 0.01-μF (minimum) ceramic capacitor rated for V <sub>CC</sub>

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#### 8.2.1.3 Application Curve

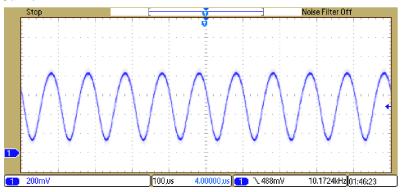


Figure 13. 10-kHz Switching Magnetic Field

#### 8.2.2 Filtered Typical Application

For lower noise on the analog output OUT, additional RC filtering can be added to further reduce the bandwidth.

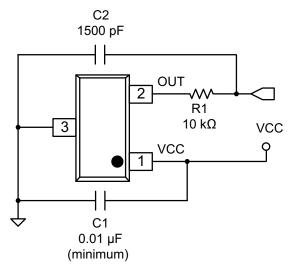


Figure 14. Filtered Typical Application Schematic

#### 8.2.2.1 Design Requirements

For this design example, use the parameters listed in Table 4 as the input parameters.

**Table 4. Design Parameters** 

DESIGN PARAMETER	REFERENCE	EXAMPLE VALUE
System bandwidth	$f_{BW}$	5 kHz

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#### 8.2.2.2 Detailed Design Procedure

In this example we will add an external RC filter in order to reduce the output bandwidth.

In order to preserve the signal at the frequencies of interest, we will conservatively select a low-pass filter bandwidth (-3-dB point) at twice the system bandwidth (10 kHz).

$$10 \text{ kHz} < \frac{1}{2\pi \times R_1 \times C_2} \tag{1}$$

If we guess R1 = 10 k $\Omega$ , then C2 < 1590 pF. So we select C2 = 1500 pF.

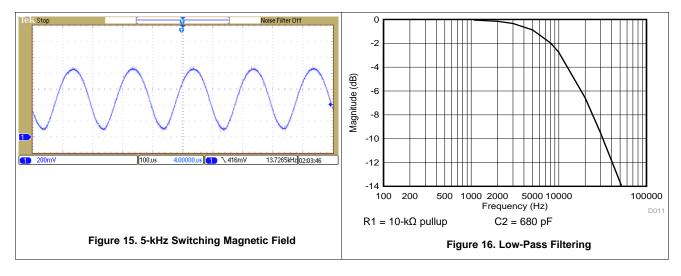
#### 8.2.2.2.1 Typical Noise Versus Cutoff Frequency

RC filters are an effective way to reduce the noise present on OUT. The following shows typical noise measurements for different cutoff frequencies using the DRV5053VA.

Table 5. DRV5053VA Typical Noise Data

R (Ω)	C (µF)	f <sub>CUTOFF</sub> (kHz)	NOISE (mVpp)
163	0.1	9.8	30.4
349	0.1	4.6	22.8
750	0.1	2.1	15.2
1505	0.1	1.1	9.7
3322	0.1	0.5	5.3
7510	0.1	0.2	2.5

#### 8.2.2.3 Application Curves



### 9 Power Supply Recommendations

The DRV5053-Q1 device is designed to operate from an input voltage supply (VM) range between 2.7 and 38 V. A 0.01- $\mu$ F (minimum) ceramic capacitor rated for V<sub>CC</sub> must be placed as close to the DRV5053-Q1 device as possible.



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DRV5053-Q1

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#### **Device and Documentation Support**

#### 10.1 Device Support

**INSTRUMENTS** 

#### 10.1.1 Device Nomenclature

Figure 17 shows a legend for reading the complete device name for and DRV5053-Q1 device.

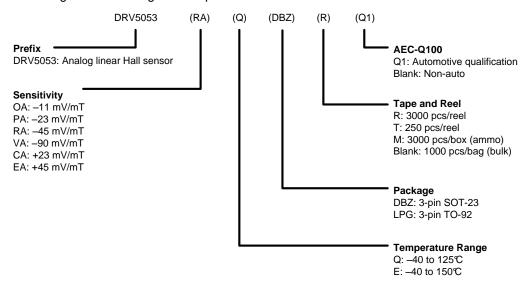


Figure 17. Device Nomenclature

#### 10.1.2 Device Markings

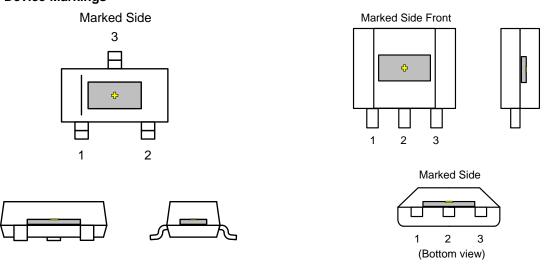


Figure 18. SOT-23 (DBZ) Package

Figure 19. TO-92 (LPG) Package

💠 indicates the Hall effect sensor (not to scale). The Hall element is located in the center of the package with a tolerance of ±100 µm. The height of the Hall element from the bottom of the package is 0.7 mm ±50 µm in the DBZ package and 0.987 mm ±50 µm in the LPG package.



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#### 10.2 Community Resources

The following links connect to TI community resources. Linked contents are provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's Terms of Use.

TI E2E™ Online Community *TI's Engineer-to-Engineer (E2E) Community.* Created to foster collaboration among engineers. At e2e.ti.com, you can ask questions, share knowledge, explore ideas and help solve problems with fellow engineers.

**Design Support** *TI's Design Support* Quickly find helpful E2E forums along with design support tools and contact information for technical support.

#### 10.3 Trademarks

E2E is a trademark of Texas Instruments.
All other trademarks are the property of their respective owners.

#### 10.4 Electrostatic Discharge Caution



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

#### 10.5 Glossary

SLYZ022 — TI Glossary.

This glossary lists and explains terms, acronyms, and definitions.

#### 11 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.



Datasheet of DRV5053CAEDBZRQ1 - IC HALL SENSOR DGTL 3SOT23

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PACKAGE OPTION ADDENDUM

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#### PACKAGING INFORMATION

Orderable Device	Status	Package Type		Pins	_		Lead/Ball Finish	MSL Peak Temp	Op Temp (°C)	Device Marking	Samples
	(1)		Drawing		Qty	(2)	(6)	(3)		(4/5)	
DRV5053CAEDBZRQ1	ACTIVE	SOT-23	DBZ	3	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 150	+AJCA	Samples
DRV5053CAEDBZTQ1	ACTIVE	SOT-23	DBZ	3	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 150	+AJCA	Samples
DRV5053CAELPGMQ1	ACTIVE	TO-92	LPG	3	3000	Green (RoHS & no Sb/Br)	CU SN	N / A for Pkg Type	-40 to 150	+AJCA	Samples
DRV5053CAELPGQ1	ACTIVE	TO-92	LPG	3	1000	Green (RoHS & no Sb/Br)	CU SN	N / A for Pkg Type	-40 to 150	+AJCA	Samples
DRV5053CAQDBZRQ1	ACTIVE	SOT-23	DBZ	3	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	+AKCA	Samples
DRV5053CAQDBZTQ1	ACTIVE	SOT-23	DBZ	3	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	+AKCA	Samples
DRV5053CAQLPGMQ1	ACTIVE	TO-92	LPG	3	3000	Green (RoHS & no Sb/Br)	CU SN	N / A for Pkg Type	-40 to 125	+AKCA	Samples
DRV5053CAQLPGQ1	ACTIVE	TO-92	LPG	3	1000	Green (RoHS & no Sb/Br)	CU SN	N / A for Pkg Type	-40 to 125	+AKCA	Samples
DRV5053EAEDBZRQ1	ACTIVE	SOT-23	DBZ	3	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 150	+AJEA	Samples
DRV5053EAEDBZTQ1	ACTIVE	SOT-23	DBZ	3	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 150	+AJEA	Samples
DRV5053EAELPGMQ1	ACTIVE	TO-92	LPG	3	3000	Green (RoHS & no Sb/Br)	CU SN	N / A for Pkg Type	-40 to 150	+AJEA	Samples
DRV5053EAELPGQ1	ACTIVE	TO-92	LPG	3	1000	Green (RoHS & no Sb/Br)	CU SN	N / A for Pkg Type	-40 to 150	+AJEA	Samples
DRV5053EAQDBZRQ1	ACTIVE	SOT-23	DBZ	3	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 150	+AKEA	Samples
DRV5053EAQDBZTQ1	ACTIVE	SOT-23	DBZ	3	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 150	+AKEA	Samples
DRV5053EAQLPGMQ1	ACTIVE	TO-92	LPG	3	3000	Green (RoHS & no Sb/Br)	CU SN	N / A for Pkg Type	-40 to 150	+AKEA	Samples
DRV5053EAQLPGQ1	ACTIVE	TO-92	LPG	3	1000	Green (RoHS & no Sb/Br)	CU SN	N / A for Pkg Type	-40 to 125	+AKEA	Samples
DRV5053OAEDBZRQ1	ACTIVE	SOT-23	DBZ	3	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 150	+AJOA	Samples

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Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead/Ball Finish	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
DRV5053OAEDBZTQ1	ACTIVE	SOT-23	DBZ	3	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 150	+AJOA	Samples
DRV5053OAELPGMQ1	ACTIVE	TO-92	LPG	3	3000	Green (RoHS & no Sb/Br)	CU SN	N / A for Pkg Type	-40 to 150	+AJOA	Samples
DRV5053OAELPGQ1	ACTIVE	TO-92	LPG	3	1000	Green (RoHS & no Sb/Br)	CU SN	N / A for Pkg Type	-40 to 150	+AJOA	Samples
DRV5053OAQDBZRQ1	ACTIVE	SOT-23	DBZ	3	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	+AKOA	Samples
DRV5053OAQDBZTQ1	ACTIVE	SOT-23	DBZ	3	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	+AKOA	Samples
DRV5053OAQLPGMQ1	ACTIVE	TO-92	LPG	3	3000	Green (RoHS & no Sb/Br)	CU SN	N / A for Pkg Type	-40 to 125	+AKOA	Samples
DRV5053OAQLPGQ1	ACTIVE	TO-92	LPG	3	1000	Green (RoHS & no Sb/Br)	CU SN	N / A for Pkg Type	-40 to 125	+AKOA	Samples
DRV5053PAEDBZRQ1	ACTIVE	SOT-23	DBZ	3	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 150	+AJPA	Samples
DRV5053PAEDBZTQ1	ACTIVE	SOT-23	DBZ	3	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 150	+AJPA	Samples
DRV5053PAELPGMQ1	ACTIVE	TO-92	LPG	3	3000	Green (RoHS & no Sb/Br)	CU SN	N / A for Pkg Type	-40 to 150	+AJPA	Samples
DRV5053PAELPGQ1	ACTIVE	TO-92	LPG	3	1000	Green (RoHS & no Sb/Br)	CU SN	N / A for Pkg Type	-40 to 150	+AJPA	Samples
DRV5053PAQDBZRQ1	ACTIVE	SOT-23	DBZ	3	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	+AKPA	Samples
DRV5053PAQDBZTQ1	ACTIVE	SOT-23	DBZ	3	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	+AKPA	Samples
DRV5053PAQLPGMQ1	ACTIVE	TO-92	LPG	3	3000	Green (RoHS & no Sb/Br)	CU SN	N / A for Pkg Type	-40 to 125	+AKPA	Samples
DRV5053PAQLPGQ1	ACTIVE	TO-92	LPG	3	1000	Green (RoHS & no Sb/Br)	CU SN	N / A for Pkg Type	-40 to 125	+AKPA	Samples
DRV5053RAEDBZRQ1	ACTIVE	SOT-23	DBZ	3	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 150	+AJRA	Samples
DRV5053RAEDBZTQ1	ACTIVE	SOT-23	DBZ	3	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 150	+AJRA	Samples
DRV5053RAELPGMQ1	ACTIVE	TO-92	LPG	3	3000	Green (RoHS & no Sb/Br)	CU SN	N / A for Pkg Type	-40 to 150	+AJRA	Samples

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Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead/Ball Finish (6)	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
DRV5053RAELPGQ1	ACTIVE	TO-92	LPG	3	1000	Green (RoHS & no Sb/Br)	CU SN	N / A for Pkg Type	-40 to 150	+AJRA	Samples
DRV5053RAQDBZRQ1	ACTIVE	SOT-23	DBZ	3	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	+AKRA	Samples
DRV5053RAQDBZTQ1	ACTIVE	SOT-23	DBZ	3	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	+AKRA	Samples
DRV5053RAQLPGMQ1	ACTIVE	TO-92	LPG	3	3000	Green (RoHS & no Sb/Br)	CU SN	N / A for Pkg Type	-40 to 125	+AKRA	Samples
DRV5053RAQLPGQ1	ACTIVE	TO-92	LPG	3	1000	Green (RoHS & no Sb/Br)	CU SN	N / A for Pkg Type		+AKRA	Samples
DRV5053VAEDBZRQ1	ACTIVE	SOT-23	DBZ	3	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 150	+AJVA	Samples
DRV5053VAEDBZTQ1	ACTIVE	SOT-23	DBZ	3	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 150	+AJVA	Samples
DRV5053VAELPGMQ1	ACTIVE	TO-92	LPG	3	3000	Green (RoHS & no Sb/Br)	CU SN	N / A for Pkg Type	-40 to 150	+AJVA	Samples
DRV5053VAELPGQ1	ACTIVE	TO-92	LPG	3	1000	Green (RoHS & no Sb/Br)	CU SN	N / A for Pkg Type	-40 to 150	+AJVA	Samples
DRV5053VAQDBZRQ1	ACTIVE	SOT-23	DBZ	3	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	+AKVA	Samples
DRV5053VAQDBZTQ1	ACTIVE	SOT-23	DBZ	3	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	+AKVA	Samples
DRV5053VAQLPGMQ1	ACTIVE	TO-92	LPG	3	3000	Green (RoHS & no Sb/Br)	CU SN	N / A for Pkg Type	-40 to 125	+AKVA	Samples
DRV5053VAQLPGQ1	ACTIVE	TO-92	LPG	3	1000	Green (RoHS & no Sb/Br)	CU SN	N / A for Pkg Type	-40 to 125	+AKVA	Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

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Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes. Pb-Free (RoHS Exempl): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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#### OTHER QUALIFIED VERSIONS OF DRV5053-Q1:

Catalog: DRV5053

NOTE: Qualified Version Definitions:

Catalog - TI's standard catalog product

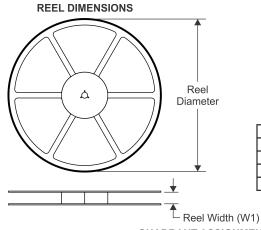
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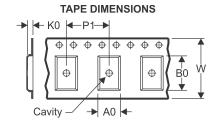


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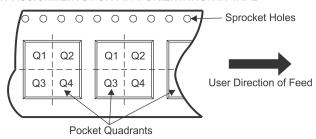
#### TAPE AND REEL INFORMATION





- A0 Dimension designed to accommodate the component width
- B0 Dimension designed to accommodate the component length
- KO Dimension designed to accommodate the component thickness
- W Overall width of the carrier tape
- P1 Pitch between successive cavity centers

#### **QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE**



#### \*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
DRV5053CAEDBZRQ1	SOT-23	DBZ	3	3000	180.0	8.4	3.15	2.77	1.22	4.0	8.0	Q3
DRV5053CAEDBZTQ1	SOT-23	DBZ	3	250	180.0	8.4	3.15	2.77	1.22	4.0	8.0	Q3
DRV5053CAQDBZRQ1	SOT-23	DBZ	3	3000	180.0	8.4	3.15	2.77	1.22	4.0	8.0	Q3
DRV5053CAQDBZTQ1	SOT-23	DBZ	3	250	180.0	8.4	3.15	2.77	1.22	4.0	8.0	Q3
DRV5053EAEDBZRQ1	SOT-23	DBZ	3	3000	180.0	8.4	3.15	2.77	1.22	4.0	8.0	Q3
DRV5053EAEDBZTQ1	SOT-23	DBZ	3	250	180.0	8.4	3.15	2.77	1.22	4.0	8.0	Q3
DRV5053EAQDBZRQ1	SOT-23	DBZ	3	3000	180.0	8.4	3.15	2.77	1.22	4.0	8.0	Q3
DRV5053EAQDBZTQ1	SOT-23	DBZ	3	250	180.0	8.4	3.15	2.77	1.22	4.0	8.0	Q3
DRV5053OAEDBZRQ1	SOT-23	DBZ	3	3000	180.0	8.4	3.15	2.77	1.22	4.0	8.0	Q3
DRV5053OAEDBZTQ1	SOT-23	DBZ	3	250	180.0	8.4	3.15	2.77	1.22	4.0	8.0	Q3
DRV5053OAQDBZRQ1	SOT-23	DBZ	3	3000	180.0	8.4	3.15	2.77	1.22	4.0	8.0	Q3
DRV5053OAQDBZTQ1	SOT-23	DBZ	3	250	180.0	8.4	3.15	2.77	1.22	4.0	8.0	Q3
DRV5053PAEDBZRQ1	SOT-23	DBZ	3	3000	180.0	8.4	3.15	2.77	1.22	4.0	8.0	Q3
DRV5053PAEDBZTQ1	SOT-23	DBZ	3	250	180.0	8.4	3.15	2.77	1.22	4.0	8.0	Q3
DRV5053PAQDBZRQ1	SOT-23	DBZ	3	3000	180.0	8.4	3.15	2.77	1.22	4.0	8.0	Q3
DRV5053PAQDBZTQ1	SOT-23	DBZ	3	250	180.0	8.4	3.15	2.77	1.22	4.0	8.0	Q3
DRV5053RAEDBZRQ1	SOT-23	DBZ	3	3000	180.0	8.4	3.15	2.77	1.22	4.0	8.0	Q3
DRV5053RAEDBZTQ1	SOT-23	DBZ	3	250	180.0	8.4	3.15	2.77	1.22	4.0	8.0	Q3



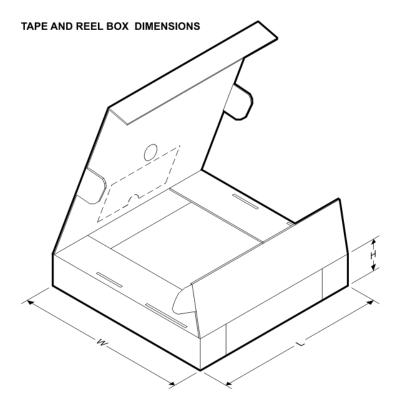
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Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
DRV5053RAQDBZRQ1	SOT-23	DBZ	3	3000	180.0	8.4	3.15	2.77	1.22	4.0	8.0	Q3
DRV5053RAQDBZTQ1	SOT-23	DBZ	3	250	180.0	8.4	3.15	2.77	1.22	4.0	8.0	Q3
DRV5053VAEDBZRQ1	SOT-23	DBZ	3	3000	180.0	8.4	3.15	2.77	1.22	4.0	8.0	Q3
DRV5053VAEDBZTQ1	SOT-23	DBZ	3	250	180.0	8.4	3.15	2.77	1.22	4.0	8.0	Q3
DRV5053VAQDBZRQ1	SOT-23	DBZ	3	3000	180.0	8.4	3.15	2.77	1.22	4.0	8.0	Q3
DRV5053VAQDBZTQ1	SOT-23	DBZ	3	250	180.0	8.4	3.15	2.77	1.22	4.0	8.0	Q3



#### \*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
DRV5053CAEDBZRQ1	SOT-23	DBZ	3	3000	202.0	201.0	28.0
DRV5053CAEDBZTQ1	SOT-23	DBZ	3	250	202.0	201.0	28.0
DRV5053CAQDBZRQ1	SOT-23	DBZ	3	3000	202.0	201.0	28.0
DRV5053CAQDBZTQ1	SOT-23	DBZ	3	250	202.0	201.0	28.0
DRV5053EAEDBZRQ1	SOT-23	DBZ	3	3000	202.0	201.0	28.0
DRV5053EAEDBZTQ1	SOT-23	DBZ	3	250	202.0	201.0	28.0
DRV5053EAQDBZRQ1	SOT-23	DBZ	3	3000	202.0	201.0	28.0
DRV5053EAQDBZTQ1	SOT-23	DBZ	3	250	202.0	201.0	28.0
DRV5053OAEDBZRQ1	SOT-23	DBZ	3	3000	202.0	201.0	28.0
DRV5053OAEDBZTQ1	SOT-23	DBZ	3	250	202.0	201.0	28.0
DRV5053OAQDBZRQ1	SOT-23	DBZ	3	3000	202.0	201.0	28.0



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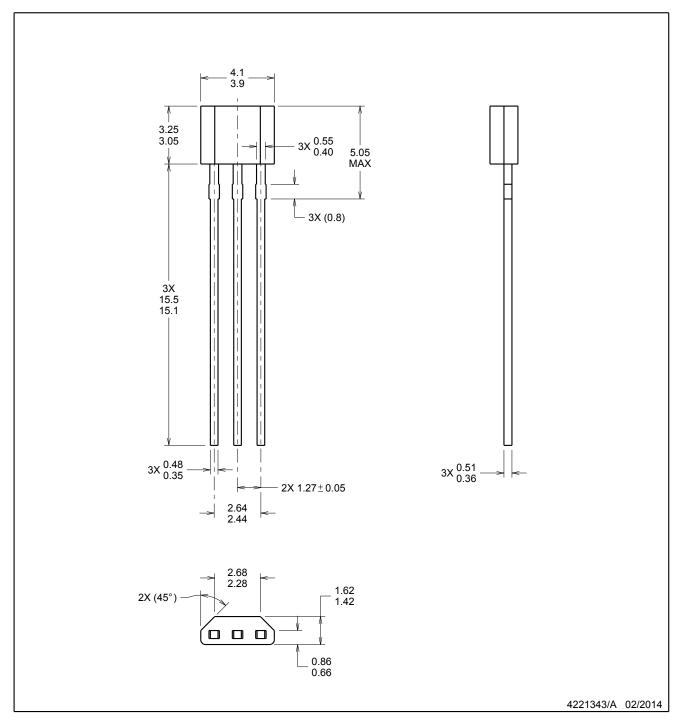
Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
DRV5053OAQDBZTQ1	SOT-23	DBZ	3	250	202.0	201.0	28.0
DRV5053PAEDBZRQ1	SOT-23	DBZ	3	3000	202.0	201.0	28.0
DRV5053PAEDBZTQ1	SOT-23	DBZ	3	250	202.0	201.0	28.0
DRV5053PAQDBZRQ1	SOT-23	DBZ	3	3000	202.0	201.0	28.0
DRV5053PAQDBZTQ1	SOT-23	DBZ	3	250	202.0	201.0	28.0
DRV5053RAEDBZRQ1	SOT-23	DBZ	3	3000	202.0	201.0	28.0
DRV5053RAEDBZTQ1	SOT-23	DBZ	3	250	202.0	201.0	28.0
DRV5053RAQDBZRQ1	SOT-23	DBZ	3	3000	202.0	201.0	28.0
DRV5053RAQDBZTQ1	SOT-23	DBZ	3	250	202.0	201.0	28.0
DRV5053VAEDBZRQ1	SOT-23	DBZ	3	3000	202.0	201.0	28.0
DRV5053VAEDBZTQ1	SOT-23	DBZ	3	250	202.0	201.0	28.0
DRV5053VAQDBZRQ1	SOT-23	DBZ	3	3000	202.0	201.0	28.0
DRV5053VAQDBZTQ1	SOT-23	DBZ	3	250	202.0	201.0	28.0



LPG0003A

### **PACKAGE OUTLINE**

TO-92 - 5.05 mm max height



#### NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.

  2. This drawing is subject to change without notice.

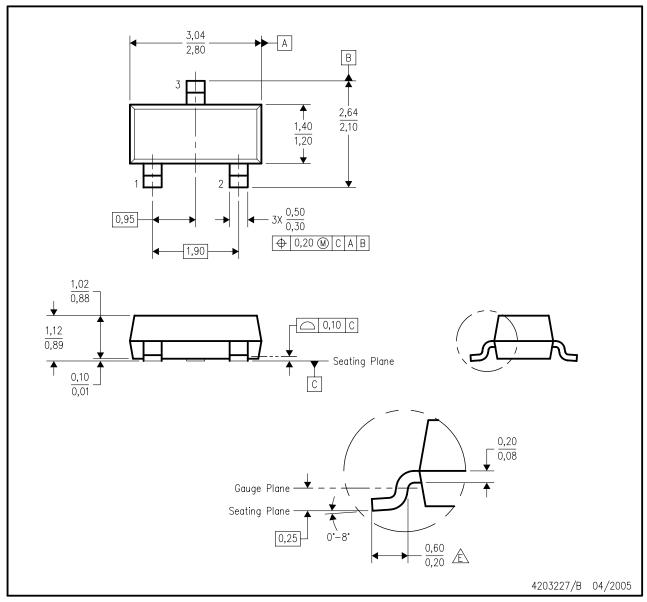




### **MECHANICAL DATA**

## DBZ (R-PDSO-G3)

### PLASTIC SMALL-OUTLINE



NOTES: All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M—1994.

- This drawing is subject to change without notice.
- Lead dimensions are inclusive of plating.

  Body dimensions are exclusive of mold flash and protrusion. Mold flash and protrusion not to exceed 0.25 per side.
- Æ Falls within JEDEC T0−236 variation AB, except minimum foot length.

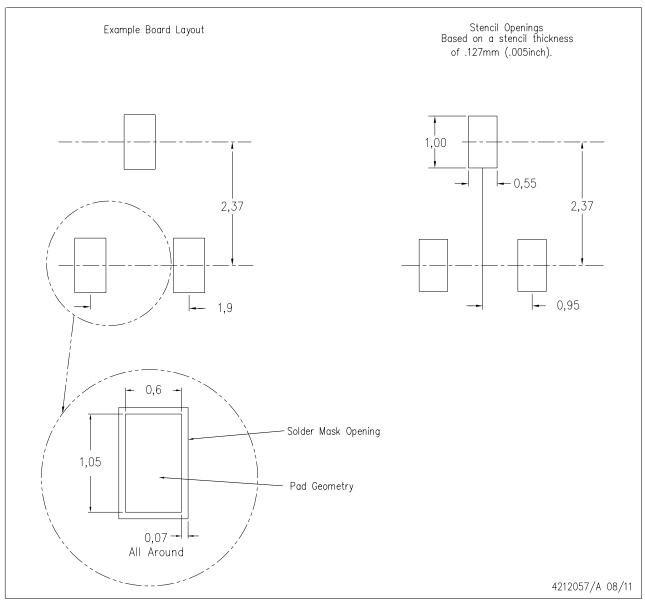




#### LAND PATTERN DATA

## DBZ (R-PDSO-G3)

### PLASTIC SMALL OUTLINE



NOTES:

- A. All linear dimensions are in millimeters.
- 3. This drawing is subject to change without notice.
- C. Customers should place a note on the circuit board fabrication drawing not to alter the center solder mask defined pad.
- D. Publication IPC-7351 is recommended for alternate designs.
- E. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Example stencil design based on a 50% volumetric metal load solder paste. Refer to IPC-7525 for other stencil recommendations.





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